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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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3.0mmx1.0 mm RIGHT ANGLE SMD **CHIP LED LAMP**

Part Number: APA3010CGCK

Green

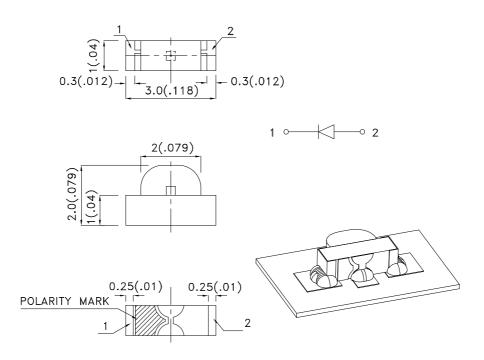
Features

- 3.0mmx1.0mm RIGHT ANGLE SMT LED, 2.0mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACK LIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- RoHS COMPLIANT.

Description

The Green source color devices are made with InGaAIP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. Specifications are subject to change without notice.4.The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

| Part No. | Dice | Lens Type | lv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|-------------|-----------------|-------------|------------------------|------|----------------------|
| | | | Min. | Тур. | 201/2 |
| APA3010CGCK | Green (InGaAIP) | WATER CLEAR | 18 | 60 | 120° |

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|--------|------|------|-------|--------------------|
| λpeak | Peak Wavelength | Green | 574 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Green | 570 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Green | 20 | | nm | IF=20mA |
| С | Capacitance | Green | 15 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Green | 2.1 | 2.5 | V | IF=20mA |
| lr | Reverse Current | Green | | 10 | uA | V _R =5V |

- Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

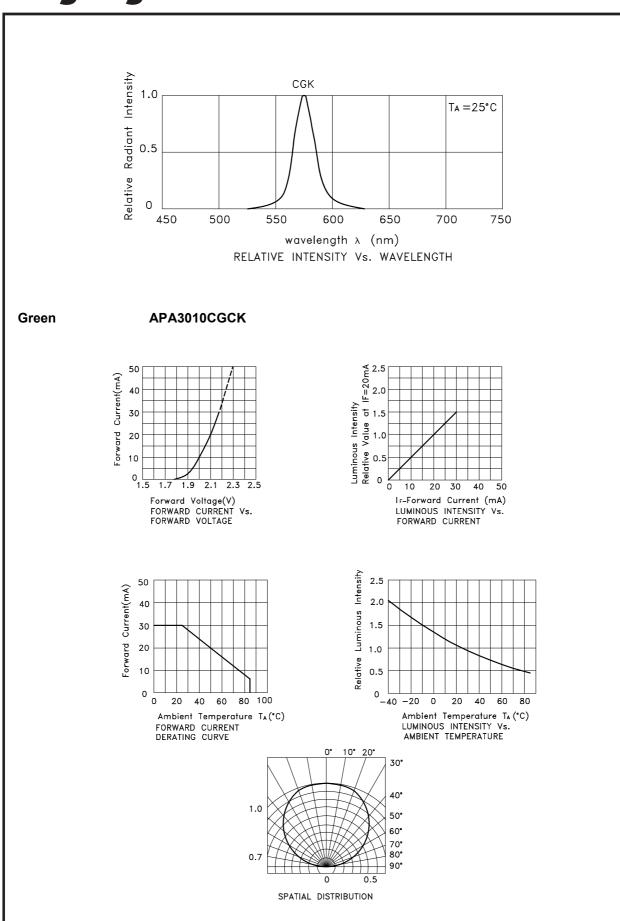
Absolute Maximum Ratings at TA=25°C

| Units | | | | | | |
|----------------|--|--|--|--|--|--|
| mW | | | | | | |
| mA | | | | | | |
| mA | | | | | | |
| V | | | | | | |
| -40°C To +85°C | | | | | | |
| -40°C To +85°C | | | | | | |
| -40°C To +85°C | | | | | | |

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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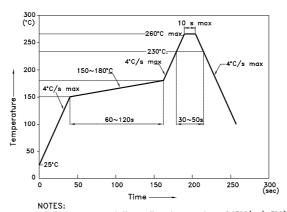


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APA3010CGCK

Reflow Soldering Profile For Lead-free SMT Process.



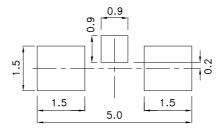
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

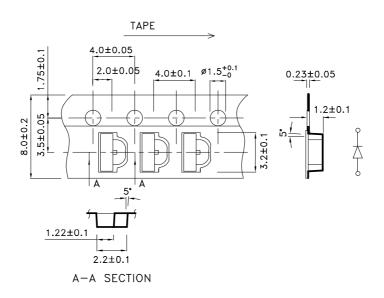
 2.Don't cause stress to the epoxy resin while it is exposed
- to high temperature.

 3.Number of reflow process shall be 2 times or less.

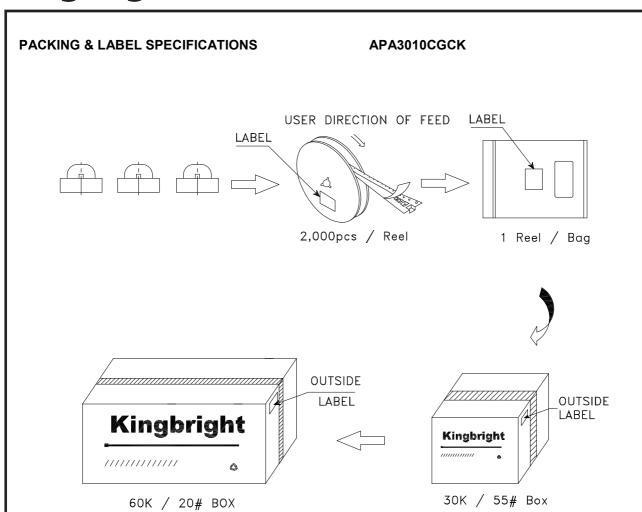
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

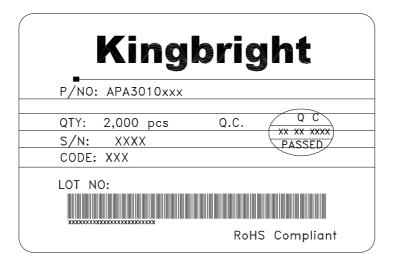


Tape Specifications (Units: mm)



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